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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/689,262	10/20/2003	Min-Chieh Chou	64,600-126	2887
570	7590 03/23/2006		EXAMINER	
AKIN GUMP STRAUSS HAUER & FELD L.L.P.			NGUYEN, JIMMY	
	ERCE SQUARE ET STREET, SUITE 2200		ART UNIT	PAPER NUMBER
	HIA, PA 19103		2829	

DATE MAILED: 03/23/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

4 · · ·			H:
	Application No.	Applicant(s)	,,,,
	10/689,262	CHOU ET AL.	
Office Action Summary	Examiner	Art Unit	
	Jimmy Nguyen	2829	
The MAILING DATE of this communication a Period for Reply	appears on the cover sheet w	ith the correspondence address	
A SHORTENED STATUTORY PERIOD FOR REI THE MAILING DATE OF THIS COMMUNICATIO - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a - If NO period for reply is specified above, the maximum statutory peri - Failure to reply within the set or extended period for reply will, by sta Any reply received by the Office later than three months after the may earned patent term adjustment. See 37 CFR 1.704(b).	N. 1.136(a). In no event, however, may a reply within the statutory minimum of thin iod will apply and will expire SIX (6) MON tute, cause the application to become Al	reply be timely filed ty (30) days will be considered timely. ITHS from the mailing date of this communication. BANDONED (35 U.S.C. § 133).	
Status			
1) Responsive to communication(s) filed on 23	3 <u>December 2005</u> .		
,	his action is non-final.		
3) Since this application is in condition for allow closed in accordance with the practice under	•		
Disposition of Claims			
4) ⊠ Claim(s) 2,3,5,7,13,18-22,24,25,33 and 34 4a) Of the above claim(s) 26 - 32 is/are with 5) □ Claim(s) is/are allowed. 6) ⊠ Claim(s) 2,3,5,7,13,18-22,24,25,33 and 34 7) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restriction and Application Papers 9) ⊠ The specification is objected to by the Example 10) ⊠ The drawing(s) filed on 20 October 2003 is/a	ndrawn from consideration. is/are rejected. d/or election requirement. iiner. are: a)⊠ accepted or b)□ o	objected to by the Examiner.	
Applicant may not request that any objection to to Replacement drawing sheet(s) including the cortain. The oath or declaration is objected to by the	rection is required if the drawing	(s) is objected to. See 37 CFR 1.121(d).	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for fore a) All b) Some * c) None of: 1. Certified copies of the priority docum. 2. Certified copies of the priority docum. 3. Copies of the certified copies of the papplication from the International Bur. * See the attached detailed Office action for a	ents have been received. ents have been received in A priority documents have beer reau (PCT Rule 17.2(a)).	Application No I received in this National Stage	
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/Paper No(s)/Mail Date	Paper No	Summary (PTO-413) s)/Mail Date Informal Patent Application (PTO-152) 	

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DETAILED ACTION

Response to Argument

The examiner acknowledges the amendment filed 12/23/05 with the following effect;

The amendments are in mood of new ground of rejection.

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States
- 2. Claims 3, 7, 18, 25, 34 are rejected under 35 U.S.C. 102(b) as being anticipated by Evans et al (US 4,975,638).

As to claims 7, 18, Evans et al disclose (figs 3, 4, 10) a probe module comprising:

a probe base (12, fig 4) having a plurality of conductive traces (T);

a plurality of probe pins (16) attached to probe base (12), each of the probe pins (16) comprising an elongated body (middle section of 16), wherein at least part of the elongated body (middle section of 16) is bonded to the plurality of conductive metal traces (T) of the probe base (12);

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a circuit interconnect device (10, fig 3) for connecting said plurality of probe pins (16) to an inspection apparatus; and

a compression arm (13, 14, fig 10) attached to the probe base (12) and configured to engage the plurality of probe pins (16).

As to claim 3, Evans et al disclose (figs 3, 4, 10) the probe module of claim 1 wherein said circuit interconnect device (10, fig 3) comprises a plurality of conductive probe circuits provided on said probe base (12, fig 4) in electrical contact with said plurality of probe pins (16), respectively, and a flexible circuit board (10) provided in electrical contact with said plurality of conductive probe circuits (T).

As to claim 25, Evans et al disclose (figs 3, 4, 10) the probe pins include an elongated arm body (the middle section of probe) such that at least a part of the elongated arm body is attached with the probe base (12).

As to claim 34, Evans et al disclose (figs 3, 4, 10) the probe module of claim 7, further comprising at least one adjustment screw (18) provided on the probe base (201) that can be manipulated to adjust the compression arm against the plurality of probe pins to adjust the contact angle of the probe pins.

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Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 2, 5, 13, 19, 20, 24 are rejected under 35 U.S.C. 103(a) as being unpatentable over Evans et al. (US 4,975,638) in view of Zhou et al. (US 2005/0035775).

As to claim 2, Evans et al disclose everything except for each of said plurality probe pins further comprises a probe pin head extending from probe pin body and generally tapered probe pin tip provided on said probe pin head.

On the other hand, Zhou et al disclose (figs 3, 4, 6) the probe module of claim 7 wherein each of said plurality probe pins (30) further comprises a probe pin head extending from probe pin body (30) and generally tapered probe pin tip (236) provided on said probe pin head.

It would have been obvious to one having an ordinary skill in the art at the time of the invention was made to modify the teaching of Evans et al and use the semi spherical probe tip or Tetrahedrall as taught by Zhou et al for the purpose of ensuring a better contact.

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As to claims 5, 13, 20, 24, Evans et al disclosed everything except for each of the plurality of probe pins further comprises a probe pin head supported by the probe pin body and generally semi-spherical probe pin tip or Tetrahedral provided on the probe pin head.

On the other hand, Zhou et al disclose (figs 3, 4, 6) each of the plurality of probe pins (28,30) further comprises a probe pin head supported by the probe pin body (30) and generally semi-spherical probe pin tip or Tetrahedral provided on the probe pin head (see fig 6).

It would have been obvious to one having an ordinary skill in the art at the time of the invention was made to modify the teaching of Evans et al and use the semi spherical probe tip or Tetrahedrall as taught by Zhou et al for the purpose of ensuring a better contact.

As to claim 19, Zhou et al disclose (figs 3, 4, 6) the probe pin tip (30) has a generally polyhedral configuration.

5. Claims 3, 21, 22, 33 are rejected under 35 U.S.C. 103(a) as being unpatentable over Evans et al (US 4,975,638) in view of Cheng et al (US 2005/0012513).

As to claim 3, Evans et al disclose (figs 3, 4, 10) the probe module of claim 7 wherein said circuit interconnect device (10, fig 3) comprises a plurality of conductive probe circuits provided on said probe base (12, fig 4) in electrical contact with said

plurality of probe pins (16), respectively, and circuit board (10) provided in electrical contact with said plurality of conductive probe circuits (T).

However, Evans et al are silent on the circuit board in electrical contact with the conductive is flexible.

On the other hand, Cheng et al teach (fig 1) the circuit board (80) in electrical contact with the conductive is flexible.

It would have been obvious to one having an ordinary skill in the art at the time of the invention was made to modify the teaching of Evans et al and use the flexible printed circuit as taught by Cheng et al for the purpose of ensuring the resilient pressure on the dut.

As to claim 21, Evans et al disclose (figs 3, 4, 10) a probe module comprising:

A probe base (12, fig 4) having a plurality of conductive metal traces (T), the probe base (12) being defined by a first end (end comes to contact with dut) and a second end (end connect with the testing apparatus);

A plurality of probe pins (16) electrically connected to the conductive metal traces (T) of the first end of the probe base (12);

A circuit board (10) electrically connected to the conductive metal traces (T) of the second end of the probe base (12), thereby allowing the plurality of the probe pins (16) to be electrically connected to the circuit board (10) via the plurality of conductive metal traces (T).

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However, Evans et al are silent on the circuit board in electrical contact with the conductive is flexible.

On the other hand, Cheng et al teach (fig 1) the circuit board (80) in electrical contact with the conductive is flexible.

It would have been obvious to one having an ordinary skill in the art at the time of the invention was made to modify the teaching of Evans et al and use the flexible printed circuit as taught by Cheng et al for the purpose of ensuring the resilient pressure on the dut.

As to claim 22, Cheng et al disclose (fig 1) a probe module comprising:

The probe module wherein the flexible circuit board (80) couples the probe pins (64) to a testing unit via the conductive metal traces.

As to claim 33, Cheng et al disclose (fig 1) the probe module of claim 2 1 wherein the plurality of probe pins (64) are electrical connected to the conductive metal traces (85) of the first end of the probe base (60) by being bonded to the probe base (60), and the flexible circuit board (80) is electrically connected to the conductive metal traces (85) of the second end of the probe base by being bonded to the probe base.

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Conclusion

Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Jimmy Nguyen whose telephone number is (703) 306-

5858. The examiner can normally be reached on M-F from 9 to 5.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Ramtiez Nestor, can be reached on 571-272-2034. The fax phone number

for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the

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JN.

March 8, 2006

VINH NGUYEN

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03/20/06